

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Won Kwon Lee
Serial No.: To be assigned
Filed: July 18, 2003 (herewith)
For: Method of Forming Isolation
Films in Semiconductor Devices
Group Art Unit: To be assigned
Examiner: To be assigned

) I hereby certify that this Patent
) Application Transmittal and the
) documents referred to as enclosed
) therewith are being deposited with the
) United States Postal Service on
) **July 18, 2003**, in an envelope addressed
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Richard Zimmermann

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Submitted herewith for consideration by the examiner are copies of the documents identified on the attached PTO SB/08. Entry and consideration of the submitted documents is solicited.

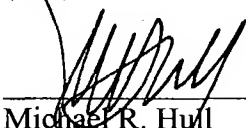
The Commissioner is authorized to charge any fee deficiency required by this paper, or credit any overpayment, to Deposit Account No. 13-2855.

Respectfully submitted,

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July 18, 2003

By:


Michael R. Hull
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Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Complete if Known		
				Application Number	To be assigned	
				Filing Date	July 18, 2003 (herewith)	
				First Named Inventor	Won Kwon Lee	
				Art Unit	To be assigned	
Examiner Name	To be assigned					
Attorney Docket Number	29936/39477					
Sheet	1	of	1			

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			
		6,413,828	07-02-2002	Lam	

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)				

¹ Applicant's unique citation designation number (optional). ² See attached Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the application number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		Li, C.H. et al. "A robust shallow trench isolation (STI) with SiN pull-back process for advanced DRAM technology," <i>Advanced Semiconductor Manufacturing 2002, IEEE/SEMI Confrence and Workshop 2002</i> pp. 21-26.	

Examiner Signature		Date Considered	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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